



Product Change Notification

Change Notification #: 114311 - 00

Change Title: Intel® Server System Product
A2U8X35S3HSDK, Intel® Server
System Product R2308WTTYSR,
PCN 114311-00, Product Design,
Front Mount Hot Swap Backplane.

Date of Publication: December 30, 2015

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 15, 2016
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Description of Change to the Customer:

Intel will make changes to the Front Mount Hot Swap Backplane (A2U8X35S3HSDK) reducing the height and the sag to remedy the Unit Space and ease the installation.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes.

Intel recommends that the customer perform a standard level of evaluation when their post-change system become available.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
A2U8X35S3HSDK	936191	H47008-002	G97160-351	H47008-003	G97160-352

PCN Revision History:

Date of Revision:

December 30, 2015

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

114311 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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